

## CMF2SMFWI510M



# Common Mode Filters

## For automobile signal line



#### **FEATURE**

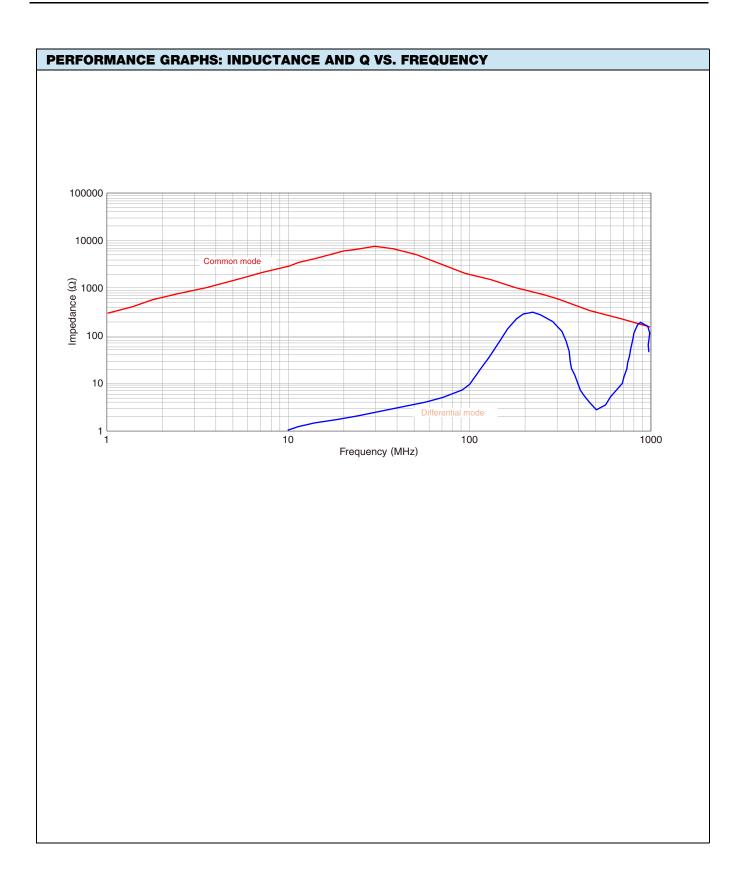
- Compatible with an operating temperature range of −40 to +105°C, so can be used for vehicle devices requiring compatibility with high temperatures.
- O When mounting, the terminal and winding tape splicing part do not fuse.
- $\bigcirc$  Which uses our unique technology, is a product that can achieve DCR <  $2\Omega$  @ 125 deg. C by reducing the DC resistance while maintaining a high L-value of  $51\mu$ H.

#### **APPLICATIONS**

O FlexRay system.

STANDARD ELECTRICAL SPECIFICATIONS							
PART NUMBER	Common mode inductance [100kHz] (uH)+50/-30%	Rated voltage (V)max.	Rated current (mA)max.	DC resistance $(\Omega)$ max.	Insulation resistance (M $\Omega$ )min.		
CMF2SMFWI510M	51	50	200	1.0	10		

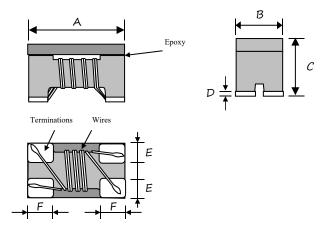






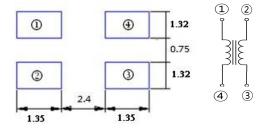
### **DIMENSIONS** in inches [millimeters]

### 2.Dimension



4532	Dimensions
Α	4.5 ± 0.2
В	3.2 ± 0.2
С	2.8 ± 0.2
D	0.2 ± 0.1
Е	1.2Тур.
F	1.0Тур.

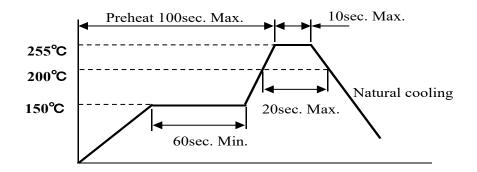
# Recommended Land Pattern Unit: mm



PIN NUMBER	DESCRIPTION		
1 ~ 4	DATA LINE		
2 ~ 3	DATA LINE		



### RECOMMENDED SOLDERING TEMP. GRAPH



ITEM P/N	CMF2SMFWI510M	TEST INSTRUMENT	4291B、4339B
PRODUCT	COMMON MODE CHOKE	TEST FREQUENCY	100 MHz / 0.5V

### **MECHANICAL RELIABILITY**

TEST	Specification & Requirement		Method Used	
	The surface of terminal/pin	tested shall	Solder heat proof:	
Solderability	be covered with new solde	r by 90%	Preheating: 150 ±10°C 60 seconds	
			Soldering: 245 ±5°C for 4 ±1 sec	
	Components should have	not evidence of	Preheating:150°C 60secs	
Solder Heat	electrical and mechannical	l damage	Solder temperature: 260±5°C	
Resistance	Impedance:within ±15% of	initial value	Flux:rosin	
			Dip time:10±0.5 secs	
	Series No.	F (Kg)	Solder a chip to test substrate and then	
	1608	0.5	laterally apply a force in the arrow direction	
Terminal strength	2012	0.5		
	3216	1.0		
	4532	1.0	1.0	
			Test Board	